## IN THE SPECIFICATION:

After "MULTI-CHIP STACKED DEVICES" and before "FIELD OF INVENTION" at column 1, line 3, please add the following paragraph:

## CROSS-REFERENCE TO RELATED APPLICATIONS

This reissue application is a continuation of United States Patent application Serial No. 08/610,127, filed February 29, 1996, now U.S. Patent Re. 36,613, reissued March 14, 2000, from U.S. Patent No. 5,291,061, dated March 1, 1994.